



Złożone systemy elektromechaniczne w mikrotechnologii i mechatronice

Indeks: **683337** Producent: **Springer** Kod producenta: **213 black & white illustrations**

Cena: **555.29 zł**

Opis

Electromechanical Systems in Microtechnology and Mechatronics: Electrical, Mechanical and Acoustic Networks, their Interactions and Applications

Producent: Springer

- **temat:** Electronics engineering, Mechanical engineering, Dynamics & vibration, Wave mechanics (vibration & acoustics), TECHNOLOGY & ENGINEERING / Electronics / General, TECHNOLOGY & ENGINEERING, Electronics, General, TECHNOLOGY & ENGINEERING / Mechanical, Mechanical, SCIENCE / Acoustics & Sound, SCIENCE, Acoustics & Sound, Electronics and Microelectronics, Instrumentation, Mechanical Engineering, Vibration, Dynamical Systems, Control, Acoustics, Multibody Systems and Mechanical Vibrations, HC/Technik/Elektronik, Elektrotechnik, Nachrichtentechnik, HC, Technik, Elektronik, Elektrotechnik, Nachrichtentechnik, HC/Technik/Maschinenbau, Fertigungstechnik, Maschinenbau, Fertigungstechnik, HC/Physik, Astronomie/Mechanik, Akustik, Physik, Astronomie, Mechanik, Akustik, Abstract Networks;Acoustic Systems;Actuators;Application of Network Theory;Distributed Parameters;Electric Transducers;Electrodynamics;Electromagnetics;Electromechanical Systems;Electromechanical Transducers;Electrostatics;Equivalent Circuit;Fluid Systems;Interconnection of Subsystems;Linearity;Lumped Parameters;Magnetic Transducers;Mechanical Systems;Resonators;Sensors;Statics and Dynamics of Systems;Thermal Systems;Transducers;Transverse Mode;Vibrations;Vibrations Transducers, Engineering: Mechanics of solids, Wave mechanics (vibration and acoustics), SCIENCE / Acoustics & Sound, SCIENCE / Mechanics / Dynamics, Science/Acoustics & Sound, Science/Mechanics - Dynamics, TECHNOLOGY & ENGINEERING / Electronics / General, TECHNOLOGY & ENGINEERING / Mechanical, Technology & Engineering/Electronics - General, Technology & Engineering/Mechanical, Dynamics & vibration, Electronics engineering, Mechanical engineering, Wave mechanics (vibration & acoustics), Elektronik, Engineering: Mechanics of solids, Festkörpermechanik, Maschinenbau, Maschinenbau: Festkörpermechanik, Wave mechanics (vibration and acoustics), Wellenmechanik (Vibration und Akustik), HC/Physik, Astronomie/Mechanik, Akustik, HC/Technik/Elektronik, Elektrotechnik, Nachrichtentechnik, HC/Technik/Maschinenbau, Fertigungstechnik, Hardcover, Softcover / Technik/Elektronik, Elektrotechnik, Nachrichtentechnik
- **wiązący:** paperback
- **język:** english, english, english
- **waga przedmiotu:** 1.52 pounds
- **strony:** 496
- **słowo kluczowe tematu:** Abstract Networks; Acoustic Systems; Actuators; Application of Network Theory; Distributed Parameters; Electric Transducers; Electrodynamics; Electromagnetics; Electromechanical Systems; Electromechanical Transducers; Electrostatics; Equivalent Circuit; Fluid Systems; Interconnection of Subsystems; Linearity; Lumped Parameters; Magnetic Transducers; Mechanical Systems; Resonators; Sensors; Statics and Dynamics of Systems; Thermal Systems; Transducers; Transverse Mode; Vibrations; Vibrations Transducers, Abstract Networks; Acoustic Systems; actuators; Application of Network Theory; Distributed parameters; Electric Transducers; electrodynamics; electromagnetics; electromechanical transducers; Electrostatics; Equivalent Circuit; Fluid Systems; Interconnection of

Subsystems; linearity; Lumped Parameters; Magnetic Transducers; mechanical systems; resonators; Sensors; Statics and Dynamics of Systems; Thermal Systems; Transducers; Transverse Mode; Vibrations; Vibrations Transducers, Abstract Networks;Acoustic Systems;Actuators;Application of Network Theory;Distributed Parameters;Electric Transducers;Electrodynamics;Electromagnetics;Electromechanical Systems;Electromechanical Transducers;Electrostatics;Equivalent Circuit;Fluid Systems;Interconnection of Subsystems;Linearity;Lumped Parameters;Magnetic Transducers;Mechanical Systems;Resonators;Sensors;Statics and Dynamics of Systems;Thermal Systems;Transducers;Transverse Mode;Vibrations;Vibrations Transducers, Non-Fiction, SCI/TECH, Science/Math

- **marka:** Springer
- **kod unspsc:** 55101500
- **kod podmiotu:** SCI001000, SCI018000, SCI001000, SCI018000, TEC008000, TEC009070, TEC008000, TEC009070, 1642, 1684, 1682, 1684, TJF, TGMD, TGMD, TGB, TGMD, PHDS, PHDS, TGMD4, TJF, TGB, PHDS
- **grupa docelowa:** General/trade
- **Liczba przedmiotów:** 1
- **numer części:** 213 black & white illustrations
- **kolor:** White
- **waga opakowania przedmiotu:** 1.66 pounds
- **wydanie:** 2011
- **numer seryjny:** 4
- **zewnętrznie przypisany identyfikator produktu:** 364226526X, 9783642265266, 09783642265266
- **producent:** Springer
- **tytuł serii:** Microtechnology and MEMS
- **autor:** Lenk, Arno, Ballas, Rüdiger G., Werthschützky, Roland, Pfeifer, Günther
- **gatunek muzyczny:** Electronics engineering, Mechanical engineering, Dynamics & vibration, Wave mechanics (vibration & acoustics), TECHNOLOGY & ENGINEERING, Electronics, General, TECHNOLOGY & ENGINEERING, Mechanical, SCIENCE, Acoustics & Sound, HC, Technik, Elektronik, Elektrotechnik, Nachrichtentechnik, HC, Technik, Maschinenbau, Fertigungstechnik, HC, Physik, Astronomie, Mechanik, Akustik, Electronics engineering, Mechanical engineering, Engineering: Mechanics of solids, Wave mechanics (vibration and acoustics)
- **Data publikacji:** 2012-12-01T00:00:01Z
- **numer wydania:** 1
- **nazwa przedmiotu:** Electromechanical Systems in Microtechnology and Mechatronics: Electrical, Mechanical and Acoustic Networks, their Interactions and Applications
- **data premiery:** 2012-12-01T00:00:01Z
- **data uruchomienia strony produktu:** 2012-11-17T15:49:29.606Z

Parametry

Dostępność	W magazynie
Format	Paperback
Wymiary	15 x 22 cm
Liczba stron	496
Wydawca	Springer
Język	Angielski